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May 2010



FDB8832_F085

N-Channel Logic Level PowerTrench® MOSFET 30V, 80A, 2.1mΩ

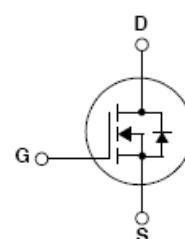
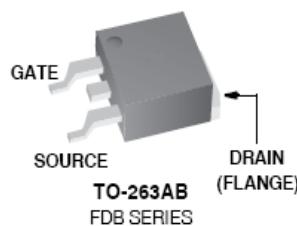
Features

- Typ $r_{DS(on)} = 1.5\text{m}\Omega$ at $V_{GS} = 5\text{V}$, $I_D = 80\text{A}$
- Typ $Q_{g(5)} = 100\text{nC}$ at $V_{GS} = 5\text{V}$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant



Applications

- 12V Automotive Load Control
- Starter / Alternator Systems
- Electronic Power Steering Systems
- ABS
- DC-DC Converters

**FDB8832_F085 N-Channel Logic Level PowerTrench® MOSFET**

MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	30	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current Continuous ($T_C < 165^\circ\text{C}$, $V_{GS} = 10\text{V}$)	80	A
	Drain Current Continuous ($T_C < 163^\circ\text{C}$, $V_{GS} = 5\text{V}$)	80	
	Drain Current Continuous ($T_{amb} = 25^\circ\text{C}$, $V_{GS} = 10\text{V}$, with $R_{\theta JA} = 43^\circ\text{C/W}$)	34	
	Pulsed	See Figure 4	
E_{AS}	Single Pulse Avalanche Energy (Note 1)	1246	mJ
P_D	Power Dissipation	300	W
	Derate above 25°C	2	$^\circ\text{C}/\text{W}$
T_J , T_{STG}	Operating and Storage Temperature	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 2)	62	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, in^2 copper pad area	43	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8832	FDB8832_F085	TO-263AB	330mm	24mm	800 units

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

V_{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24\text{V}$ $V_{GS} = 0\text{V}$	-	-	1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 100	nA

On Characteristics

$r_{DS(on)}$	Drain to Source On Resistance	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	1.0	1.6	3.0	V
		$I_D = 80\text{A}$, $V_{GS} = 10\text{V}$	-	1.4	1.9	$\text{m}\Omega$
		$I_D = 80\text{A}$, $V_{GS} = 5\text{V}$	-	1.5	2.1	
		$I_D = 80\text{A}$, $V_{GS} = 4.5\text{V}$	-	1.6	2.2	
		$I_D = 80\text{A}$, $V_{GS} = 10\text{V}$ $T_J = 175^\circ\text{C}$	-	2.3	3.0	

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 15\text{V}$, $V_{GS} = 0\text{V}$, $f = 1\text{MHz}$	-	11400	-	pF
C_{oss}	Output Capacitance		-	2140	-	pF
C_{rss}	Reverse Transfer Capacitance		-	1260	-	pF
R_G	Gate Resistance	$V_{GS} = 0.5\text{V}$, $f = 1\text{MHz}$	-	1.2	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	-	204	265	nC
$Q_{g(5)}$	Total Gate Charge at 5V	$V_{GS} = 0$ to 5V	-	100	130	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0$ to 1V	$V_{DD} = 15\text{V}$ $I_D = 80\text{A}$ $I_g = 1.0\text{mA}$	10.9	14.2	nC
Q_{gs}	Gate to Source Gate Charge	$V_{GS} = 0$ to 1V	$V_{DD} = 15\text{V}$ $I_D = 80\text{A}$ $I_g = 1.0\text{mA}$	33	-	nC
Q_{gs2}	Gate Charge Threshold to Plateau			22	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			43	-	nC

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Switching Characteristics						
$t_{(on)}$	Turn-On Time	$V_{DD} = 15\text{V}$, $I_D = 80\text{A}$ $V_{GS} = 5\text{V}$, $R_{GS} = 1.5\Omega$	-	-	155	ns
$t_{d(on)}$	Turn-On Delay Time		-	24	-	ns
t_r	Turn-On Rise Time		-	73	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	54	-	ns
t_f	Turn-Off Fall Time		-	38	-	ns
t_{off}	Turn-Off Time		-	-	149	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 75\text{A}$	-	0.8	1.25	V
		$I_{SD} = 40\text{A}$	-	0.8	1.0	V
t_{rr}	Reverse Recovery Time	$I_F = 75\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$	-	59	77	ns
		$I_F = 75\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$	-	67	87	nC

Notes:

1: Starting $T_J = 25^\circ\text{C}$, $L = 0.61\text{mH}$, $I_{AS} = 64\text{A}$, $V_{DD} = 30\text{V}$, $V_{GS} = 10\text{V}$.

2: Pulse width = 100s.

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: <http://www.aecouncil.com/>
 All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

Typical Characteristics

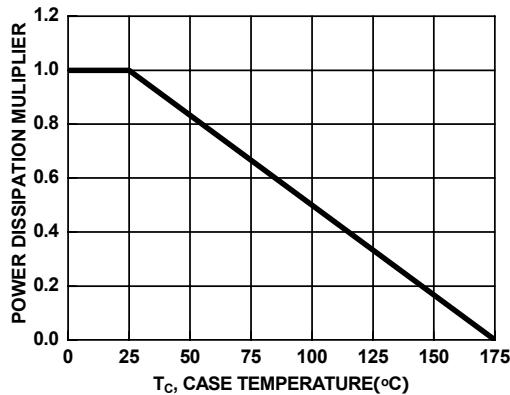


Figure 1. Normalized Power Dissipation vs Case Temperature

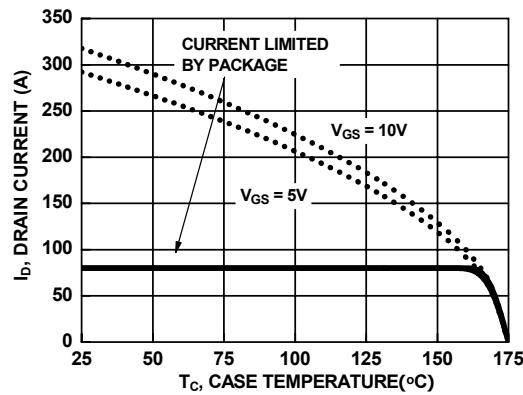


Figure 2. Maximum Continuous Drain Current vs Case Temperature

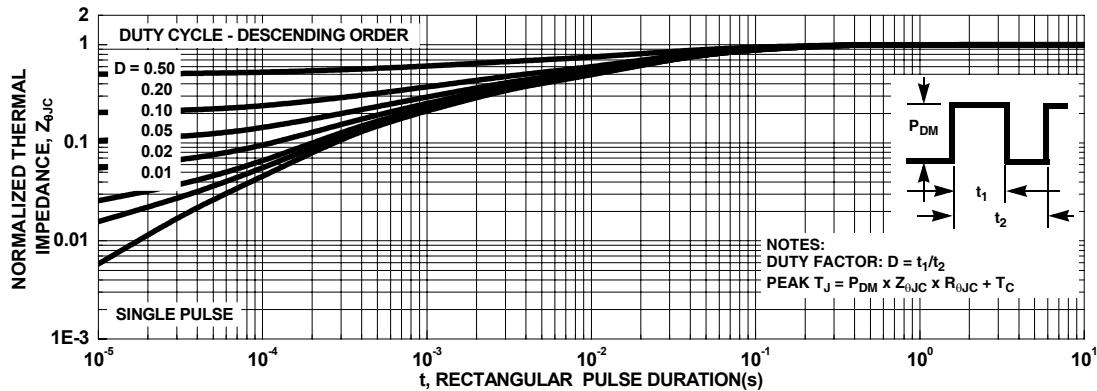


Figure 3. Normalized Maximum Transient Thermal Impedance

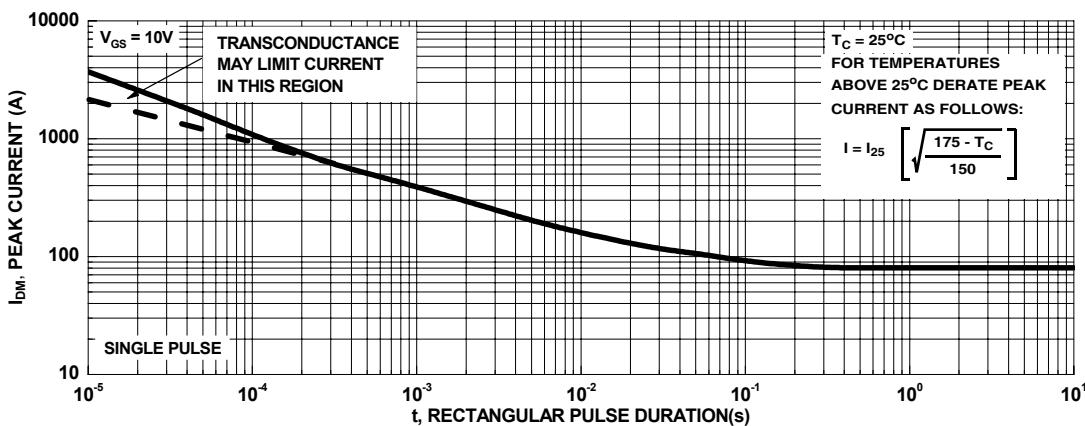


Figure 4. Peak Current Capability

Typical Characteristics

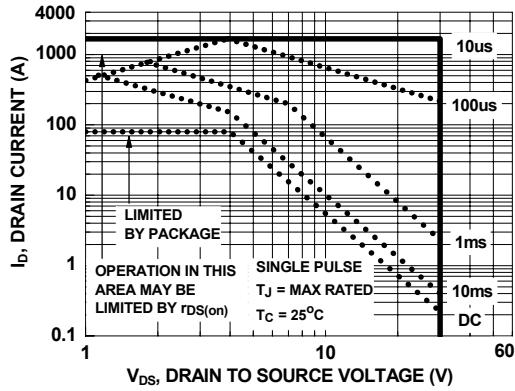
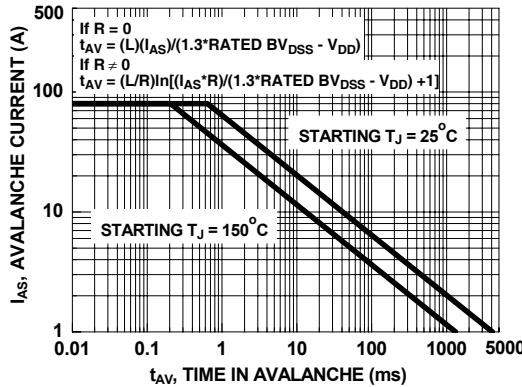


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

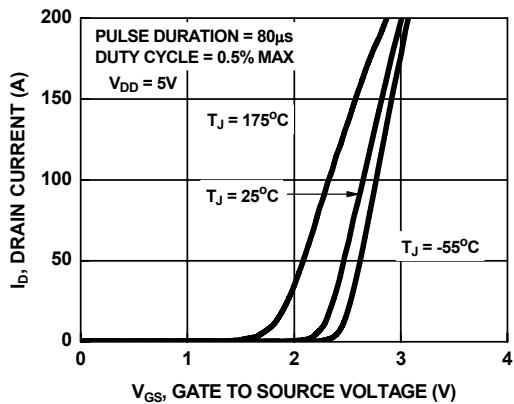


Figure 7. Transfer Characteristics

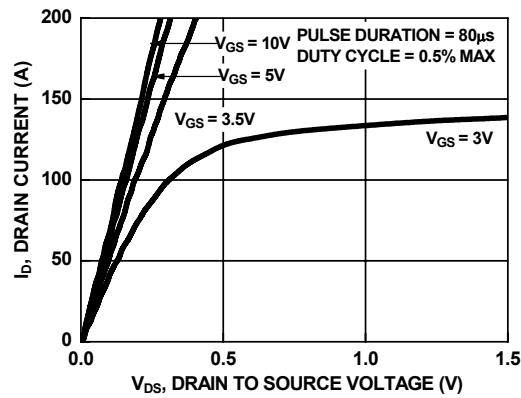


Figure 8. Saturation Characteristics

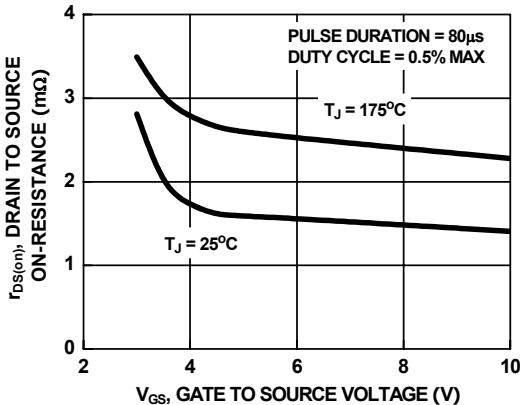


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

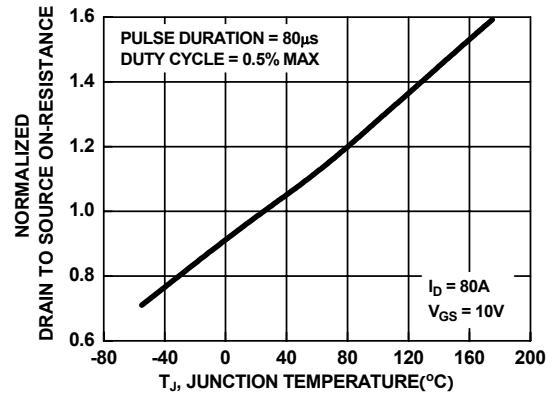


Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

Typical Characteristics

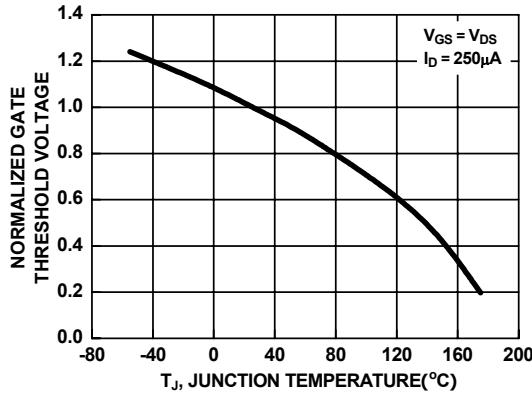


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

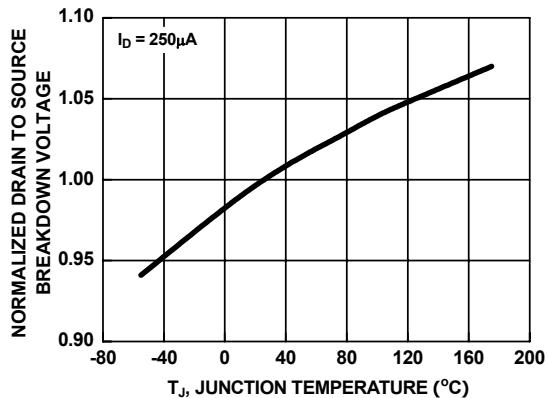


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

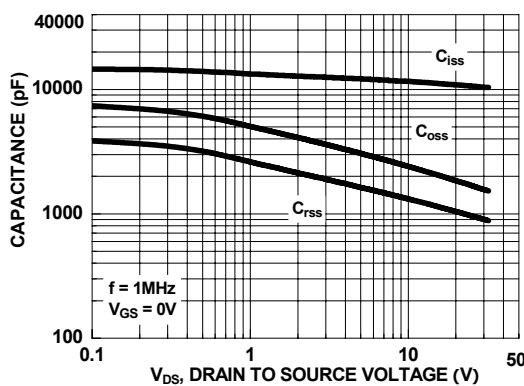


Figure 13. Capacitance vs Drain to Source Voltage

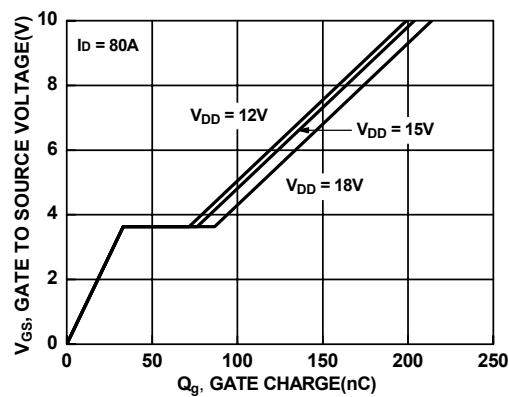


Figure 14. Gate Charge vs Gate to Source Voltage



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